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"**Embedded - Microcontrollers**" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "**Embedded - Microcontrollers**"

Details	
Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.600", 15.24mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f081apj020sc

The pin configurations listed are preliminary and subject to change based on manufacturing limitations.
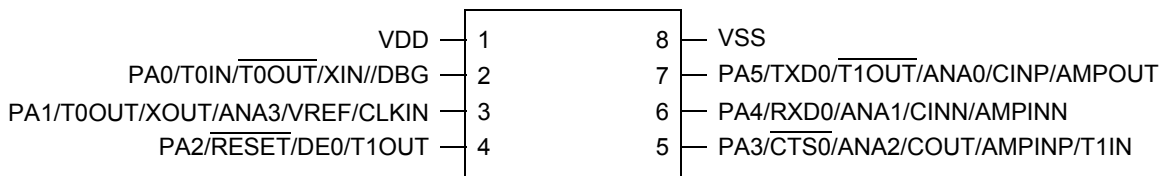

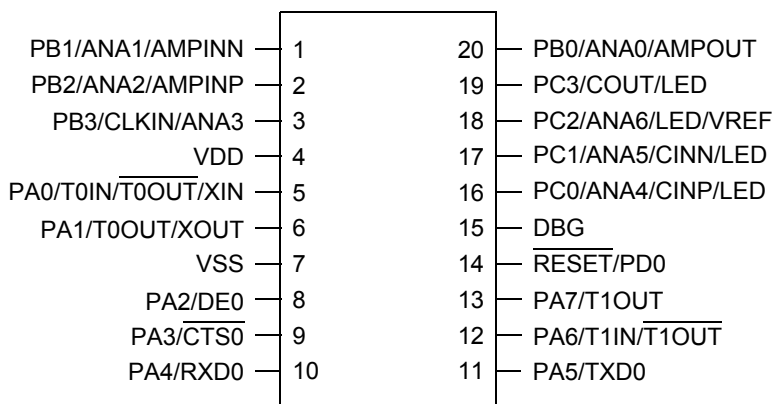**Figure 2. Z8F08xA, Z8F04xA, Z8F02xA, and Z8F01xA in 8-Pin SOIC, QFN/MLF-S, or PDIP Package**

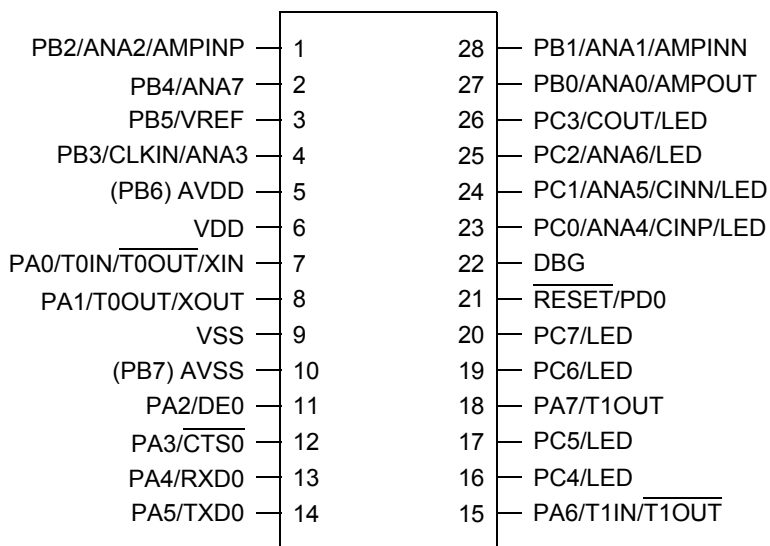**Figure 3. Z8F08xA, Z8F04xA, Z8F02xA, and Z8F01xA in 20-Pin SOIC, SSOP or PDIP Package**

Figure 4. Z8F08xA, Z8F04xA, Z8F02xA, and Z8F01xA in 28-Pin SOIC, SSOP or PDIP Package

Table 14. Port Alternate Function Mapping (Non 8-Pin Parts)

Port	Pin	Mnemonic	Alternate Function Description	Alternate Function Set Register AFS1
Port A	PA0	T0IN/$\overline{\text{T0OUT}}$*	Timer 0 Input/Timer 0 Output Complement	N/A
		Reserved		
	PA1	T0OUT	Timer 0 Output	
		Reserved		
	PA2	DE0	UART 0 Driver Enable	
		Reserved		
	PA3	$\overline{\text{CTS0}}$	UART 0 Clear to Send	
		Reserved		
	PA4	RXD0/IRRX0	UART 0/IrDA 0 Receive Data	
		Reserved		
	PA5	TXD0/IRTX0	UART 0/IrDA 0 Transmit Data	
		Reserved		
	PA6	T1IN/$\overline{\text{T1OUT}}$*	Timer 1 Input/Timer 1 Output Complement	
		Reserved		
	PA7	T1OUT	Timer 1 Output	
		Reserved		

Note: Because there is only a single alternate function for each Port A pin, the Alternate Function Set registers are not implemented for Port A. Enabling alternate function selections as described in Port A–D Alternate Function Sub-Registers on page 47 automatically enables the associated alternate function.

* Whether PA0/PA6 take on the timer input or timer output complement function depends on the timer configuration as described in Timer Pin Signal Operation on page 82.

Interrupt Request 2 Register

The Interrupt Request 2 (IRQ2) register (Table 35) stores interrupt requests for both vectored and polled interrupts. When a request is presented to the interrupt controller, the corresponding bit in the IRQ2 register becomes 1. If interrupts are globally enabled (vectored interrupts), the interrupt controller passes an interrupt request to the eZ8 CPU. If interrupts are globally disabled (polled interrupts), the eZ8 CPU can read the Interrupt Request 2 register to determine if any interrupt requests are pending.

Table 35. Interrupt Request 2 Register (IRQ2)

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved				PC3I	PC2I	PC1I	PC0I
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	FC6H							

Reserved—Must be 0.

PC*x*I—Port C Pin *x* Interrupt Request
0 = No interrupt request is pending for GPIO Port C pin *x*.
1 = An interrupt request from GPIO Port C pin *x* is awaiting service.

where *x* indicates the specific GPIO Port C pin number (0–3).

IRQ0 Enable High and Low Bit Registers

Table 36 describes the priority control for IRQ0. The IRQ0 Enable High and Low Bit registers (Table 37 and Table 38) form a priority encoded enabling for interrupts in the Interrupt Request 0 register.

Table 36. IRQ0 Enable and Priority Encoding

IRQ0ENH[*x*]	IRQ0ENL[*x*]	Priority	Description
0	0	Disabled	Disabled
0	1	Level 1	Low
1	0	Level 2	Medium
1	1	Level 3	High

where *x* indicates the register bits from 0–7.

Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state for one system clock cycle (from Low to High or from High to Low) upon timer Reload. If it is appropriate to have the Timer Output make a state change at a One-Shot time-out (rather than a single cycle pulse), first set the TPOL bit in the Timer Control Register to the start value before enabling ONE-SHOT mode. After starting the timer, set TPOL to the opposite bit value.

Follow the steps below for configuring a timer for ONE-SHOT mode and initiating the count:

1. Write to the Timer Control register to:
   – Disable the timer
   – Configure the timer for ONE-SHOT mode.
   – Set the prescale value.
   – Set the initial output level (High or Low) if using the Timer Output alternate function.

2. Write to the Timer High and Low Byte registers to set the starting count value.

3. Write to the Timer Reload High and Low Byte registers to set the Reload value.

4. If appropriate, enable the timer interrupt and set the timer interrupt priority by writing to the relevant interrupt registers.

5. If using the Timer Output function, configure the associated GPIO port pin for the Timer Output alternate function.

6. Write to the Timer Control register to enable the timer and initiate counting.

In ONE-SHOT mode, the system clock always provides the timer input. The timer period is given by the following equation:

$$\text{ONE-SHOT Mode Time-Out Period (s)} = \frac{\text{Reload Value} - \text{Start Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

CONTINUOUS Mode

In CONTINUOUS mode, the timer counts up to the 16-bit Reload value stored in the Timer Reload High and Low Byte registers. The timer input is the system clock. Upon reaching the Reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to 0001H and counting resumes. Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state (from Low to High or from High to Low) at timer Reload.

Follow the steps below for configuring a timer for CONTINUOUS mode and initiating the count:

1. Write to the Timer Control register to:
   – Disable the timer
   – Configure the timer for CONTINUOUS mode.

- Set the prescale value.
- If using the Timer Output alternate function, set the initial output level (High or Low).

2. Write to the Timer High and Low Byte registers to set the starting count value (usually `0001H`). This action only affects the first pass in CONTINUOUS mode. After the first timer Reload in CONTINUOUS mode, counting always begins at the reset value of `0001H`.

3. Write to the Timer Reload High and Low Byte registers to set the Reload value.

4. Enable the timer interrupt (if appropriate) and set the timer interrupt priority by writing to the relevant interrupt registers.

5. Configure the associated GPIO port pin (if using the Timer Output function) for the Timer Output alternate function.

6. Write to the Timer Control register to enable the timer and initiate counting.

In CONTINUOUS mode, the system clock always provides the timer input. The timer period is given by the following equation:

$$\text{CONTINUOUS Mode Time-Out Period (s)} = \frac{\text{Reload Value} \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

If an initial starting value other than `0001H` is loaded into the Timer High and Low Byte registers, use the ONE-SHOT mode equation to determine the first time-out period.

COUNTER Mode

In COUNTER mode, the timer counts input transitions from a GPIO port pin. The timer input is taken from the GPIO Port pin Timer Input alternate function. The TPOL bit in the Timer Control Register selects whether the count occurs on the rising edge or the falling edge of the Timer Input signal. In COUNTER mode, the prescaler is disabled.

⚠ **Caution:** *The input frequency of the Timer Input signal must not exceed one-fourth the system clock frequency. Further, the high or low state of the input signal pulse must be no less than twice the system clock period. A shorter pulse may not be captured.*

Upon reaching the Reload value stored in the Timer Reload High and Low Byte registers, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to `0001H` and counting resumes. Also, if the Timer Output alternate function is enabled, the Timer Output pin changes state (from Low to High or from High to Low) at timer Reload.

Follow the steps below for configuring a timer for CAPTURE mode and initiating the count:

1. Write to the Timer Control register to:
   – Disable the timer.
   – Configure the timer for CAPTURE mode.
   – Set the prescale value.
   – Set the Capture edge (rising or falling) for the Timer Input.

2. Write to the Timer High and Low Byte registers to set the starting count value (typically `0001H`).

3. Write to the Timer Reload High and Low Byte registers to set the Reload value.

4. Clear the Timer PWM High and Low Byte registers to `0000H`. Clearing these registers allows the software to determine if interrupts were generated by either a capture event or a reload. If the PWM High and Low Byte registers still contain `0000H` after the interrupt, the interrupt was generated by a Reload.

5. Enable the timer interrupt, if appropriate, and set the timer interrupt priority by writing to the relevant interrupt registers. By default, the timer interrupt is generated for both input capture and reload events. If appropriate, configure the timer interrupt to be generated only at the input capture event or the reload event by setting TICONFIG field of the TxCTL0 register.

6. Configure the associated GPIO port pin for the Timer Input alternate function.

7. Write to the Timer Control register to enable the timer and initiate counting.

In CAPTURE mode, the elapsed time from timer start to Capture event can be calculated using the following equation:

$$\text{Capture Elapsed Time (s)} = \frac{(\text{Capture Value} - \text{Start Value}) \times \text{Prescale}}{\text{System Clock Frequency (Hz)}}$$

CAPTURE RESTART Mode

In CAPTURE RESTART mode, the current timer count value is recorded when the acceptable external Timer Input transition occurs. The Capture count value is written to the Timer PWM High and Low Byte Registers. The timer input is the system clock. The TPOL bit in the Timer Control register determines if the Capture occurs on a rising edge or a falling edge of the Timer Input signal. When the Capture event occurs, an interrupt is generated and the count value in the Timer High and Low Byte registers is reset to `0001H` and counting resumes. The INPCAP bit in TxCTL0 register is set to indicate the timer interrupt is because of an input capture event.

If no Capture event occurs, the timer counts up to the 16-bit Compare value stored in the Timer Reload High and Low Byte registers. Upon reaching the Reload value, the timer generates an interrupt, the count value in the Timer High and Low Byte registers is reset to
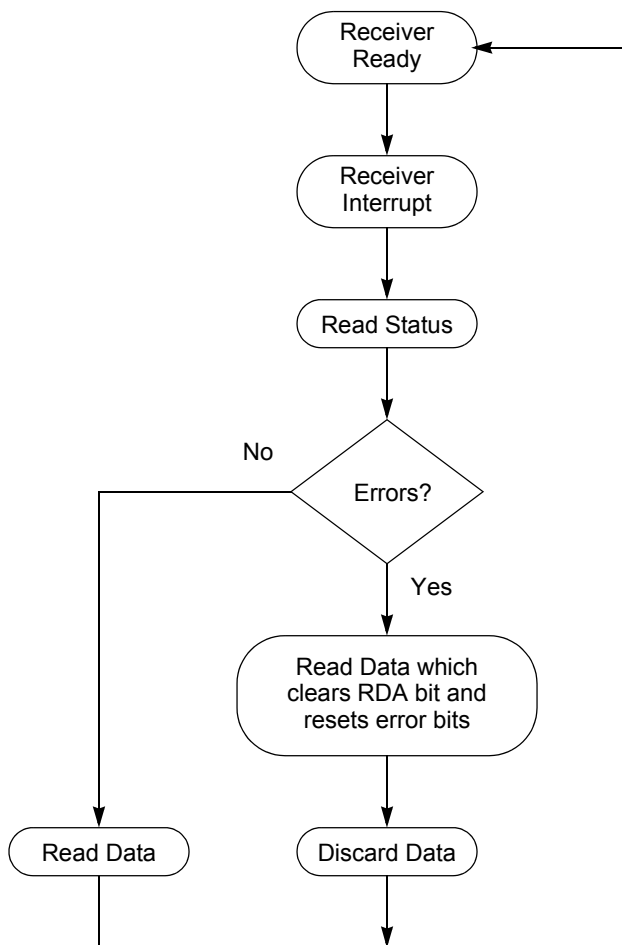
Figure 15. UART Receiver Interrupt Service Routine Flow

Baud Rate Generator Interrupts

If the baud rate generator (BRG) interrupt enable is set, the UART Receiver interrupt asserts when the UART Baud Rate Generator reloads. This condition allows the Baud Rate Generator to function as an additional counter if the UART functionality is not employed.

UART Baud Rate Generator

The UART Baud Rate Generator creates a lower frequency baud rate clock for data transmission. The input to the Baud Rate Generator is the system clock. The UART Baud Rate High and Low Byte registers combine to create a 16-bit baud rate divisor value

Infrared Encoder/Decoder

The Z8 Encore! XP® F082A Series products contain a fully-functional, high-performance UART to Infrared Encoder/Decoder (Endec). The Infrared Endec is integrated with an on-chip UART to allow easy communication between the Z8 Encore! and IrDA Physical Layer Specification, Version 1.3-compliant infrared transceivers. Infrared communication provides secure, reliable, low-cost, point-to-point communication between PCs, PDAs, cell phones, printers, and other infrared enabled devices.

Architecture

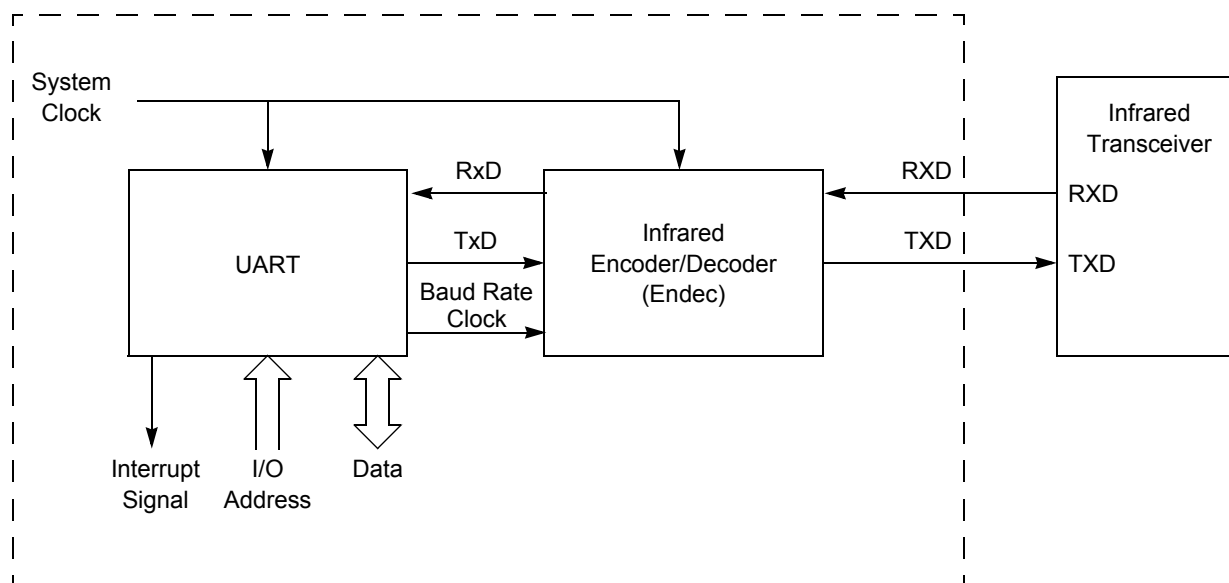Figure 16 displays the architecture of the Infrared Endec.

Figure 16. Infrared Data Communication System Block Diagram

Operation

When the Infrared Endec is enabled, the transmit data from the associated on-chip UART is encoded as digital signals in accordance with the IrDA standard and output to the infrared transceiver through the TXD pin. Likewise, data received from the infrared transceiver is passed to the Infrared Endec through the RXD pin, decoded by the Infrared

Endec, and passed to the UART. Communication is half-duplex, which means simultaneous data transmission and reception is not allowed.

The baud rate is set by the UART's Baud Rate Generator and supports IrDA standard baud rates from 9600 baud to 115.2 kbaud. Higher baud rates are possible, but do not meet IrDA specifications. The UART must be enabled to use the Infrared Endec. The Infrared Endec data rate is calculated using the following equation:

$$\text{Infrared Data Rate (bits/s)} = \frac{\text{System Clock Frequency (Hz)}}{16 \times \text{UART Baud Rate Divisor Value}}$$

Transmitting IrDA Data

The data to be transmitted using the infrared transceiver is first sent to the UART. The UART's transmit signal (TXD) and baud rate clock are used by the IrDA to generate the modulation signal (IR_TXD) that drives the infrared transceiver. Each UART/Infrared data bit is 16 clocks wide. If the data to be transmitted is 1, the IR_TXD signal remains low for the full 16 clock period. If the data to be transmitted is 0, the transmitter first outputs a 7 clock low period, followed by a 3 clock high pulse. Finally, a 6 clock low pulse is output to complete the full 16 clock data period. Figure 17 displays IrDA data transmission. When the Infrared Endec is enabled, the UART's TXD signal is internal to the Z8 Encore! XP® F082A Series products while the IR_TXD signal is output through the TXD pin.
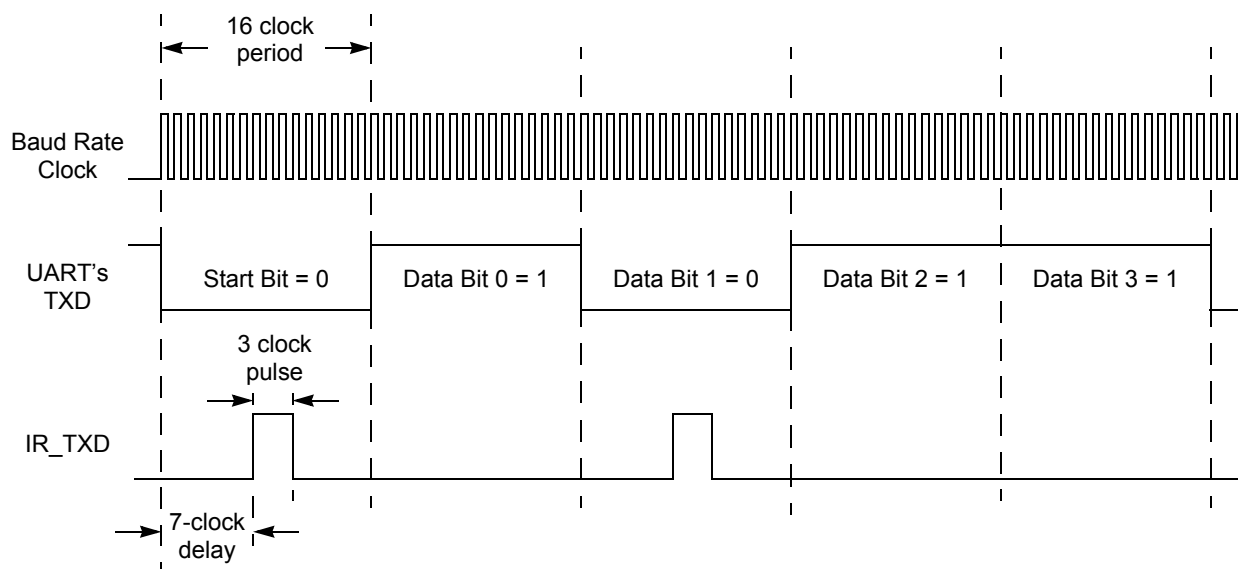

Figure 17. Infrared Data Transmission

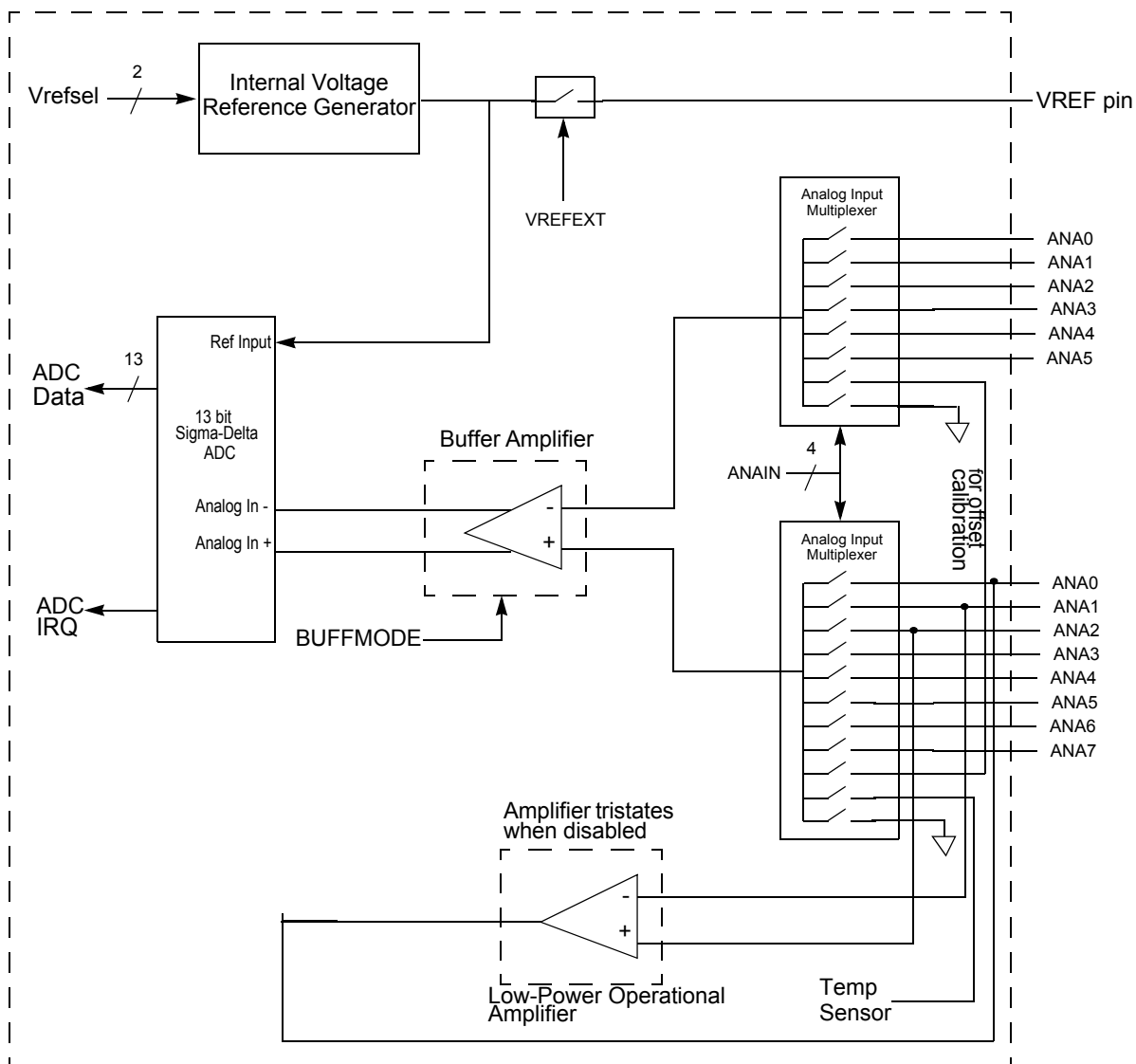**Figure 19. Analog-to-Digital Converter Block Diagram**

Operation

Data Format

In both SINGLE-ENDED and DIFFERENTIAL modes, the effective output of the ADC is an 11-bit, signed, two's complement digital value. In DIFFERENTIAL mode, the ADC

can output values across the entire 11-bit range, from -1024 to +1023. In SINGLE-ENDED mode, the output generally ranges from 0 to +1023, but offset errors can cause small negative values.

The ADC registers actually return 13 bits of data, but the two LSBs are intended for compensation use only. When the software compensation routine is performed on the 13 bit raw ADC value, two bits of resolution are lost because of a rounding error. As a result, the final value is an 11-bit number.

Hardware Overflow

When the hardware overflow bit (OVF) is set in ADC Data Low Byte (ADCD_L) register, all other data bits are invalid. The hardware overflow bit is set for values greater than V_{ref} and less than $-V_{ref}$ (DIFFERENTIAL mode).

Automatic Powerdown

If the ADC is idle (no conversions in progress) for 160 consecutive system clock cycles, portions of the ADC are automatically powered down. From this powerdown state, the ADC requires 40 system clock cycles to power up. The ADC powers up when a conversion is requested by the ADC Control register.

Single-Shot Conversion

When configured for single-shot conversion, the ADC performs a single analog-to-digital conversion on the selected analog input channel. After completion of the conversion, the ADC shuts down. Follow the steps below for setting up the ADC and initiating a single-shot conversion:

1. Enable the desired analog inputs by configuring the general-purpose I/O pins for alternate analog function. This configuration disables the digital input and output drivers.

2. Write the ADC Control/Status Register 1 to configure the ADC.

    – Write to BUFMODE[2:0] to select SINGLE-ENDED or DIFFERENTIAL mode, as well as unbuffered or buffered mode.

    – Write the REFSELH bit of the pair {REFSELH, REFSELL} to select the internal voltage reference level or to disable the internal reference. The REFSELL bit is. contained in the ADC Control Register 0.

3. Write to the ADC Control Register 0 to configure the ADC and begin the conversion. The bit fields in the ADC Control register can be written simultaneously (the ADC can be configured and enabled with the same write instruction):

    – Write to the ANAIN[3:0] field to select from the available analog input sources (different input pins available depending on the device).

    – Clear CONT to 0 to select a single-shot conversion.

⚠ **Caution:** *Although the ADC can be used without the gain and offset compensation, it does exhibit non-unity gain. Designing the ADC with sub-unity gain reduces noise across the ADC range but requires the ADC results to be scaled by a factor of 8/7.*

ADC Compensation Details

High efficiency assembly code that performs this compensation is available for download on www.zilog.com. The following is a bit-specific description of the ADC compensation process used by this code.

The following data bit definitions are used:

0-9, a-f = bit indices in hexadecimal
s = sign bit
v = overflow bit
- = unused

Input Data

```
     MSB                     LSB

s b a 9 8 7 6 5    4 3 2 1 0 - - v  (ADC)        ADC Output Word; if v = 1,
                                                 the data is invalid


                   s 6 5 4 3 2 1 0                Offset Correction Byte


s s s s s 7 6 5    4 3 2 1 0 0 0 0  (Offset)     Offset Byte shifted to align
                                                 with ADC data


s e d c b a 9 8    7 6 5 4 3 2 1 0  (Gain)       Gain Correction Word
```

1001 = 1.8 V
1010–1111 = Reserved

For 8-pin devices:

000000 = 0.00 V
000001 = 0.05 V
000010 = 0.10 V
000011 = 0.15 V
000100 = 0.20 V
000101 = 0.25 V
000110 = 0.30 V
000111 = 0.35 V
001000 = 0.40 V
001001 = 0.45 V
001010 = 0.50 V
001011 = 0.55 V
001100 = 0.60 V
001101 = 0.65 V
001110 = 0.70 V
001111 = 0.75 V
010000 = 0.80 V
010001 = 0.85 V
010010 = 0.90 V
010011 = 0.95 V
010100 = 1.00 V (Default)
010101 = 1.05 V
010110 = 1.10 V
010111 = 1.15 V
011000 = 1.20 V
011001 = 1.25 V
011010 = 1.30 V
011011 = 1.35 V
011100 = 1.40 V
011101 = 1.45 V
011110 = 1.50 V
011111 = 1.55 V
100000 = 1.60 V
100001 = 1.65 V
100010 = 1.70 V
100011 = 1.75 V
100100 = 1.80 V

the OCD or via the Flash Controller Bypass mode are unaffected. After a bit of the Sector Protect Register has been set, it cannot be cleared except by powering down the device.

Byte Programming

The Flash Memory is enabled for byte programming after unlocking the Flash Controller and successfully enabling either Mass Erase or Page Erase. When the Flash Controller is unlocked and Mass Erase is successfully completed, all Program Memory locations are available for byte programming. In contrast, when the Flash Controller is unlocked and Page Erase is successfully completed, only the locations of the selected page are available for byte programming. An erased Flash byte contains all 1's (FFH). The programming operation can only be used to change bits from 1 to 0. To change a Flash bit (or multiple bits) from 0 to 1 requires execution of either the Page Erase or Mass Erase commands.

Byte Programming can be accomplished using the On-Chip Debugger's Write Memory command or eZ8 CPU execution of the LDC or LDCI instructions. Refer to the *eZ8 CPU User Manual* (available for download at www.zilog.com) for a description of the LDC and LDCI instructions. While the Flash Controller programs the Flash memory, the eZ8 CPU idles but the system clock and on-chip peripherals continue to operate. To exit programming mode and lock the Flash, write any value to the Flash Control register, except the Mass Erase or Page Erase commands.

⚠ **Caution:** *The byte at each address of the Flash memory cannot be programmed (any bits written to 0) more than twice before an erase cycle occurs. Doing so may result in corrupted data at the target byte.*

Page Erase

The Flash memory can be erased one page (512 bytes) at a time. Page Erasing the Flash memory sets all bytes in that page to the value FFH. The Flash Page Select register identifies the page to be erased. Only a page residing in an unprotected sector can be erased. With the Flash Controller unlocked and the active page set, writing the value 95h to the Flash Control register initiates the Page Erase operation. While the Flash Controller executes the Page Erase operation, the eZ8 CPU idles but the system clock and on-chip peripherals continue to operate. The eZ8 CPU resumes operation after the Page Erase operation completes. If the Page Erase operation is performed using the On-Chip Debugger, poll the Flash Status register to determine when the Page Erase operation is complete. When the Page Erase is complete, the Flash Controller returns to its locked state.

Mass Erase

The Flash memory can also be Mass Erased using the Flash Controller, but only by using the On-Chip Debugger. Mass Erasing the Flash memory sets all bytes to the value FFH. With the Flash Controller unlocked and the Mass Erase successfully enabled, writing the

Flash Program Memory Address 0001H

Table 87. Flash Options Bits at Program Memory Address 0001H

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved			XTLDIS	Reserved			
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	Program Memory 0001H							
Note: U = Unchanged by Reset. R/W = Read/Write.								

Reserved—Must be 1.

XTLDIS—State of Crystal Oscillator at Reset.

> **Note:** *This bit only enables the crystal oscillator. Its selection as system clock must be done manually.*
> *0 = Crystal oscillator is enabled during reset, resulting in longer reset timing*
> *1 = Crystal oscillator is disabled during reset, resulting in shorter reset timing*

> **Warning:** *Programming the XTLDIS bit to zero on 8-pin versions of this device prevents any further communication via the debug pin. This is due to the fact that the XIN and DBG functions are shared on pin 2 of this package. Do not program this bit to zero on 8-pin devices unless no further debugging or Flash programming is required.*

Trim Bit Address Space

All available Trim bit addresses and their functions are listed in Table 88 through Table 92.

Trim Bit Address 0000H

Table 88. Trim Options Bits at Address 0000H

BITS	7	6	5	4	3	2	1	0
FIELD	Reserved							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	Information Page Memory 0020H							
Note: U = Unchanged by Reset. R/W = Read/Write.								

Reserved—Altering this register may result in incorrect device operation.

Non-Volatile Data Storage

The Z8 Encore! XP® F082A Series devices contain a non-volatile data storage (NVDS) element of up to 128 bytes. This memory can perform over 100,000 write cycles.

Operation

The NVDS is implemented by special purpose Zilog® software stored in areas of program memory, which are not user-accessible. These special-purpose routines use the Flash memory to store the data. The routines incorporate a dynamic addressing scheme to maximize the write/erase endurance of the Flash.

> **Note:** *Different members of the Z8 Encore! XP F082A Series feature multiple NVDS array sizes. See Z8 Encore! XP® F082A Series Family Part Selection Guide on page 3 for details. Also the members containing 8 KB of Flash memory do not include the NVDS feature.*

NVDS Code Interface

Two routines are required to access the NVDS: a write routine and a read routine. Both of these routines are accessed with a CALL instruction to a pre-defined address outside of the user-accessible program memory. Both the NVDS address and data are single-byte values. Because these routines disturb the working register set, user code must ensure that any required working register values are preserved by pushing them onto the stack or by changing the working register pointer just prior to NVDS execution.

During both read and write accesses to the NVDS, interrupt service is NOT disabled. Any interrupts that occur during the NVDS execution must take care not to disturb the working register and existing stack contents or else the array may become corrupted. Disabling interrupts before executing NVDS operations is recommended.

Use of the NVDS requires 15 bytes of available stack space. Also, the contents of the working register set are overwritten.

For correct NVDS operation, the Flash Frequency Registers must be programmed based on the system clock frequency (see Flash Operation Timing Using the Flash Frequency Registers on page 145).

Byte Write

To write a byte to the NVDS array, the user code must first push the address, then the data byte onto the stack. The user code issues a CALL instruction to the address of the byte-write routine (0x10B3). At the return from the sub-routine, the write status byte

Table 124. eZ8 CPU Instruction Summary (Continued)

Assembly Mnemonic	Symbolic Operation	Address Mode dst	src	Opcode(s) (Hex)	C	Z	S	V	D	H	Fetch Cycles	Instr. Cycles
AND dst, src	dst ← dst AND src	r	r	52	–	*	*	0	–	–	2	3
		r	Ir	53							2	4
		R	R	54							3	3
		R	IR	55							3	4
		R	IM	56							3	3
		IR	IM	57							3	4
ANDX dst, src	dst ← dst AND src	ER	ER	58	–	*	*	0	–	–	4	3
		ER	IM	59							4	3
ATM	Block all interrupt and DMA requests during execution of the next 3 instructions			2F	–	–	–	–	–	–	1	2
BCLR bit, dst	dst[bit] ← 0	r		E2	–	–	–	–	–	–	2	2
BIT p, bit, dst	dst[bit] ← p	r		E2	–	–	–	–	–	–	2	2
BRK	Debugger Break			00	–	–	–	–	–	–	1	1
BSET bit, dst	dst[bit] ← 1	r		E2	–	–	–	–	–	–	2	2
BSWAP dst	dst[7:0] ← dst[0:7]	R		D5	X	*	*	0	–	–	2	2
BTJ p, bit, src, dst	if src[bit] = p PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4
BTJNZ bit, src, dst	if src[bit] = 1 PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4
BTJZ bit, src, dst	if src[bit] = 0 PC ← PC + X		r	F6	–	–	–	–	–	–	3	3
			Ir	F7							3	4
CALL dst	SP ← SP -2 @SP ← PC PC ← dst	IRR		D4	–	–	–	–	–	–	2	6
		DA		D6							3	3
CCF	C ← ~C			EF	*	–	–	–	–	––	1	2
CLR dst	dst ← 00H	R		B0	–	–	–	–	–	–	2	2
		IR		B1							2	3

Flags Notation: * = Value is a function of the result of the operation. 0 = Reset to 0
– = Unaffected 1 = Set to 1
X = Undefined

Electrical Characteristics

Figure 41 displays the 8-pin Quad Flat No-Lead package (QFN)/MLF-S available for the Z8 Encore! XP F082A Series devices. This package has a footprint identical to that of the 8-pin SOIC, but with a lower profile.
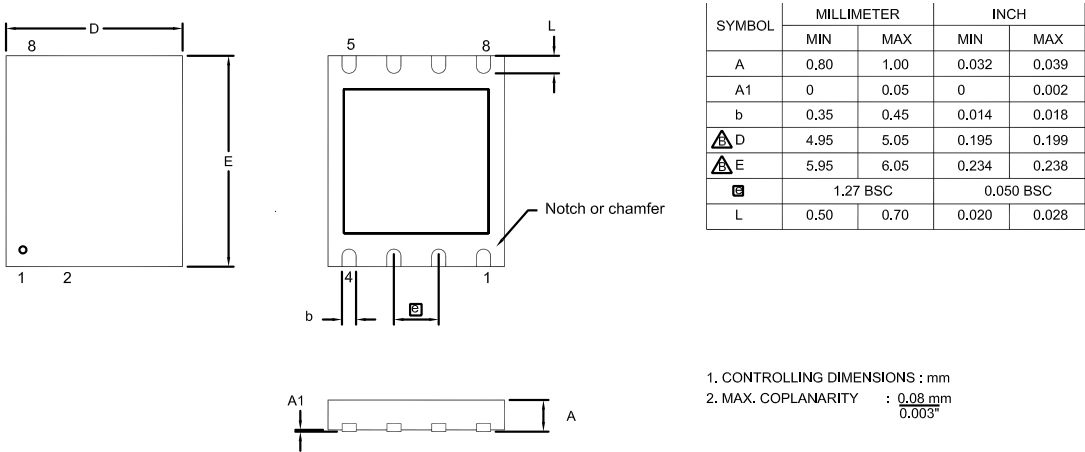

SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	0.80	1.00	0.032	0.039
A1	0	0.05	0	0.002
b	0.35	0.45	0.014	0.018
⚠ D	4.95	5.05	0.195	0.199
⚠ E	5.95	6.05	0.234	0.238
e	1.27 BSC		0.050 BSC	
L	0.50	0.70	0.020	0.028

1. CONTROLLING DIMENSIONS : mm
2. MAX. COPLANARITY   : 0.08 mm
                          0.003"

Figure 41. 8-Pin Quad Flat No-Lead Package (QFN)/MLF-S

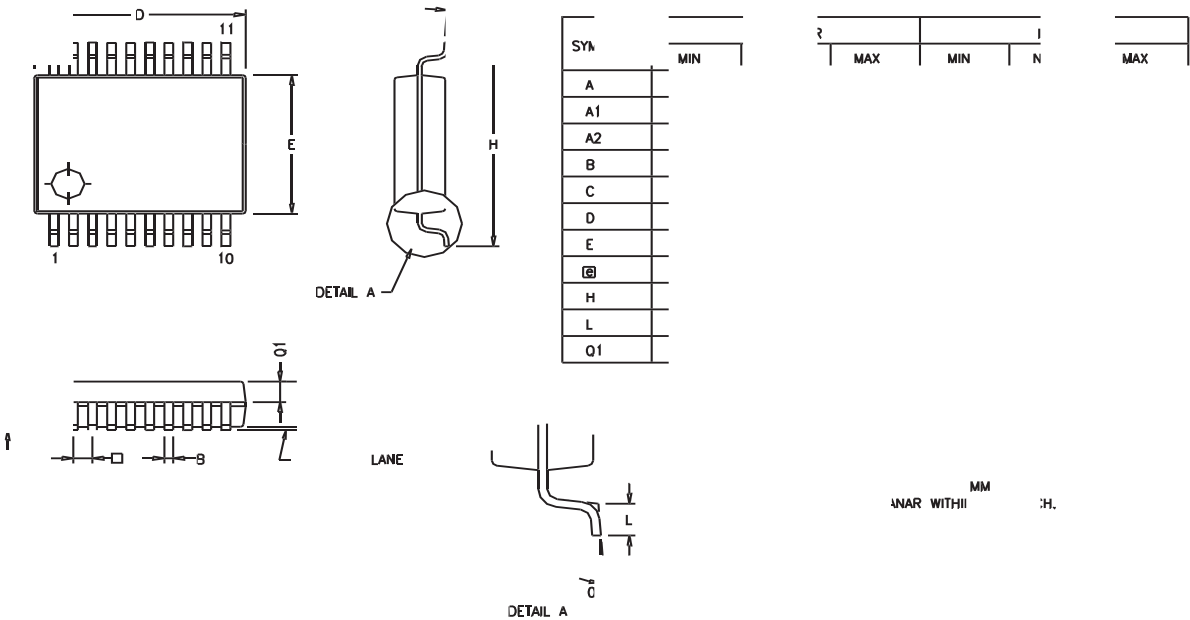displays the 20-pin Small Shrink Outline Package (SSOP) available for the
Z8 Encore! XP F082A Series devices.

Figure 44. 20-Pin Small Shrink Outline Package (SSOP)